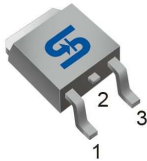




TO-252
(DPAK)



Pin Definition:

1. Gate
2. Drain
3. Source

PRODUCT SUMMARY

V _{DS} (V)	R _{DS(on)} (mΩ)	I _D (A)
100	13 @ V _{GS} =10V	70

Features

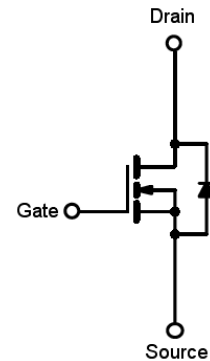
- Advanced Trench Technology
- Low R_{DS(ON)} 13mΩ (Max.)
- Low gate charge typical @ 145nC (Typ.)
- Low Crss typical @ 120pF (Typ.)

Ordering Information

Part No.	Package	Packing
TSM70N10CP ROG	TO-252	2.5Kpcs / 13" Reel

Note: "G" denote for Halogen Free Product

Block Diagram



N-Channel MOSFET

Absolute Maximum Rating (Ta = 25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	T _C =25°C	70
		T _C =70°C	61
		T _A =25°C	12
		T _A =70°C	9
Drain Current-Pulsed Note 1	I _{DM}	150	A
Avalanche Current, L=0.5mH	I _{AS} , I _{AR}	25	A
Avalanche Energy, L=0.5mH	E _{AS} , E _{AR}	156	mJ
Maximum Power Dissipation	P _D	T _C =25°C	120
		T _C =70°C	80
		T _A =25°C	8.3
		T _A =70°C	5.3
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	T _J	-55 to +150	°C

* Limited by maximum junction temperature

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance - Junction to Case	Rθ _{JC}	1	°C/W
Thermal Resistance - Junction to Ambient	Rθ _{JA}	40	°C/W

Notes: Surface mounted on FR4 board t ≤ 10sec

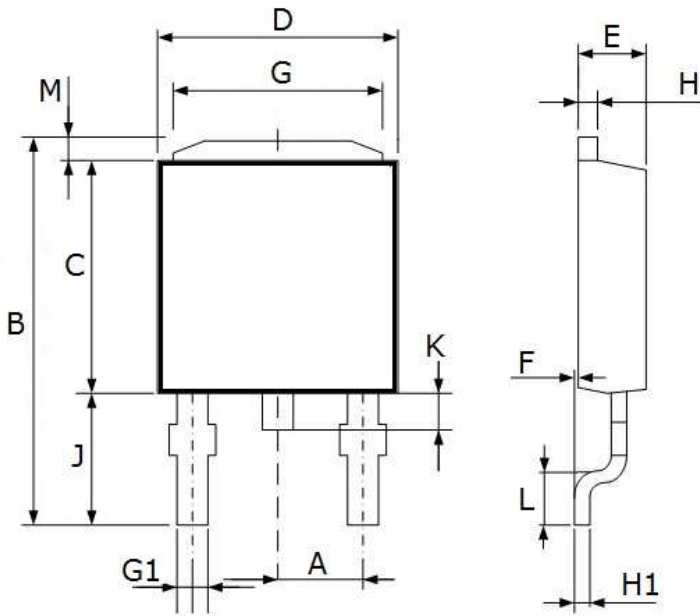
Electrical Specifications (Ta = 25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	BV_{DSS}	100	--	--	V
Drain-Source On-State Resistance	$V_{GS} = 10V, I_D = 30A$	$R_{DS(ON)}$	--	10	13	mΩ
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	$V_{GS(TH)}$	2	3	4	V
Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$	I_{DSS}	--	--	1	μA
Gate Body Leakage	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	--	--	±100	nA
Dynamic						
Total Gate Charge	$V_{DS} = 50V, I_D = 30A,$ $V_{GS} = 10V$	Q_g	--	145	--	nC
Gate-Source Charge		Q_{gs}	--	25	--	
Gate-Drain Charge		Q_{gd}	--	43	--	
Input Capacitance	$V_{DS} = 30V, V_{GS} = 0V,$ $f = 1.0MHz$	C_{iss}	--	4300	--	pF
Output Capacitance		C_{oss}	--	300	--	
Reverse Transfer Capacitance		C_{rss}	--	120	--	
Switching						
Turn-On Delay Time	$V_{GS} = 10V, V_{DS} = 50V,$ $R_G = 3\Omega$	$t_{d(on)}$	--	27	--	nS
Turn-On Rise Time		t_r	--	13	--	
Turn-Off Delay Time		$t_{d(off)}$	--	15	--	
Turn-Off Fall Time		t_f	--	42	--	
Drain-Source Diode Characteristics and Maximum Rating						
Drain-Source Diode Forward Voltage	$V_{GS}=0V, I_S=30A$	V_{SD}	-	0.8	1.3	V
Reverse Recovery Time	$I_S = 30A, T_J=25^\circ C$ $di/dt = 100A/\mu s$	t_{fr}		165		nS
Reverse Recovery Charge		Q_{fr}		175		nC

Notes:

- Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
- $R\theta_{JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R\theta_{JC}$ is guaranteed by design while $R\theta_{CA}$ is determined by the user's board design. $R\theta_{JA}$ shown below for single device operation on FR-4 in still air

TO-252 Mechanical Drawing



TO-252 DIMENSION				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	2.286 BSC		0.090 BSC	
B	9.40	10.40	0.370	0.409
C	5.40	6.23	0.213	0.245
D	6.40	6.80	0.252	0.268
E	2.20	2.40	0.087	0.094
F	0.00	0.20	0.000	0.008
G	5.20	5.50	0.205	0.217
G1	0.50	0.91	0.020	0.036
H	0.45	0.60	0.018	0.024
H1	0.40	0.60	0.016	0.024
J	2.50	2.90	0.098	0.114
K	0.60	1.00	0.023	0.039
L	1.40	1.78	0.055	0.070
M	0.88	1.28	0.034	0.050

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